

General Description

The ZLM0302AC uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. This device may be used as a load switch or in PWM applications.

Applications

- load switch
- portable power source
- Switching Power Supply
- wireless charging

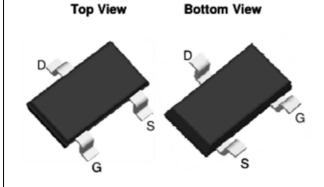
Product Summary

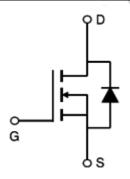
 \bullet V_{DS} 30V

● I_D (at V_{GS} =10V) 5A

• $R_{DS(ON)}$ (at $V_{GS} = 10V$) < $31m\Omega$

• $R_{DS(ON)}$ (at V_{GS} =4.5V) < 43m Ω





Absolute MaximumRatings (T_A=25℃unless otherwisenoted)

Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	±20	V	
Continuous Dunin Comment	T _A =25℃	I _D	5		
ContinuousDrain Current	T _A =70℃		4	A	
PulsedDrainCurrent ^C	1	I _{DM}	20	Α	
Power Dissipation ^B	T _A =25℃	T _A =25℃ P _D 1.4		W	
	T _A =70℃		0.9	VV	
Storage Temperature Range		T _{STG}	-55 to +150	С	
Operating Junction Temperature Range		TJ	-55 to +150	C	
Thermal Resistance, Junction-to-Ambie	nt ^A	$R_{\theta JA}$	80	°C/W	

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Electrical Characteristics (TJ=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC F	PARAMETERS	•	•	•	•	•
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250uA, V _{GS} =0V	30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V,V _{GS} =0V			1	uA
I _{GSS}	Gate-Bodyleakagecurrent	V _{DS} =0V,V _{GS} =±20V			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_{D}=250uA$	1.2	1.8	2.4	V
I _{D(ON)}	Onstate draincurrent	V _{GS} =10V,V _{DS} =5V	20			Α
R _{DS(ON)} StaticDrain-Source On-Resistance	V _{GS} =10V,I _D =1A		26	31	mΩ	
	StaticDrain-Source On-Resistance	V _{GS} =4.5V,I _D =1A		34	43	mΩ
g _{FS}	ForwardTransconductance	V _{DS} =5V,I _D =5A		15)	S
V _{SD}	Diode Forward Voltage	I _{DS} =1A,V _{GS} =0V		0.7	1	V
Is	Maximum Body-Diode ContinuousCurre	nt			1.5	Α
DYNAMIC	PARAMETERS					
C _{iss}	InputCapacitance	\/ -0\/\/ -45\/		255		pF
C _{oss}	OutputCapacitance	V_{GS} =0V, V_{DS} =15V, V_{GS} =15V,		45		pF
C _{rss}	Reverse TransferCapacitance	1-11/11/12		35		pF
SWITCHI	NG PARAMETERS	·		, 0		
Q _g	TotalGate Charge	V _{GS} =10V,V _{DS} =15V,		5.2		nC
Q _{gs}	Gate Source Charge	I _D =5A		0.85		nC
Q_{gd}	Gate Drain Charge	,		1.3		nC
$t_{D(on)}$	Turn-OnDelayTime			4.5		ns
t _r	Turn-On Rise Time	V _{GS} =10V,V _{DS} =15V,		2.5		ns
t _{D(off)}	Turn-OffDelayTime	$R_L=3\Omega, R_{GEN}=3\Omega$		14.5		ns
t _f	Turn-OffFallTime	4 4		3.5		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =5A,dI/dt=100A/μs		8.5		ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =5A,dI/dt=100A/μs		2.2		nC

Notes:

- A. The value of R $_{\theta JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design.
- B. The power dissipation P D is based on $T_{J(MAX)}$ =150°C, using \leq 10s junction-to-ambient thermal resistance
- C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ =150°C. Ratings are based on low frequency and duty cycles to keep initial T_J =25°C.
- D. The static characteristics in Figures 1 to 6 are obtained using <300µs pulses, duty cycle 0.5% max
- E. These curves are based on the junction-to-ambient thermal impedence which is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, assuming a maximum junction temperature of $T_{J(MAX)}$ =150°C. The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

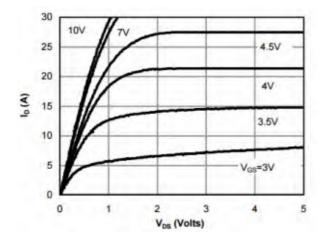


Fig 1: On-Region Characteristics (Note D)

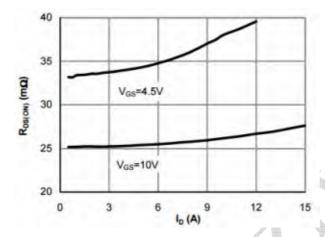


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note D)

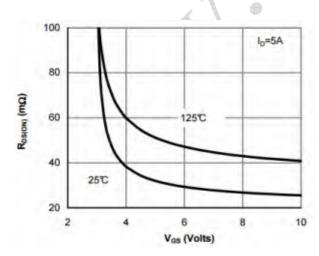


Figure 5: On-Resistance vs. Gate-Source Voltage (Note D)

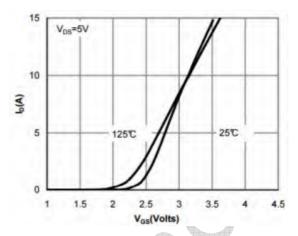


Figure 2: Transfer Characteristics (Note D)

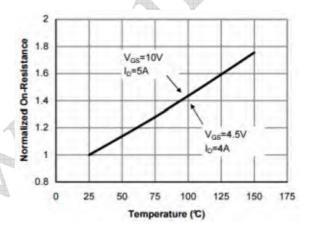


Figure 4: On-Resistance vs. Junction Temperature (Note D)

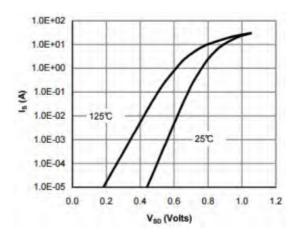
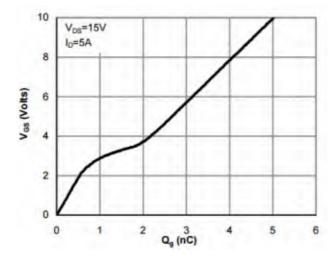


Figure 6: Body-Diode Characteristics (Note D)

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





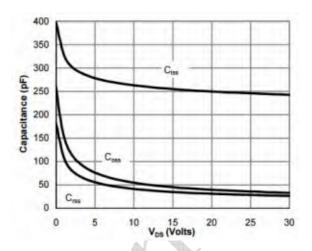


Figure 8: Capacitance Characteristics

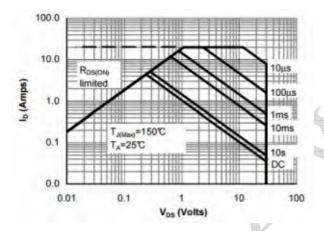


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

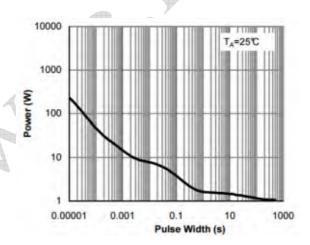


Figure 10: Single Pulse Power Rating Junction--to-Ambient (Note E)

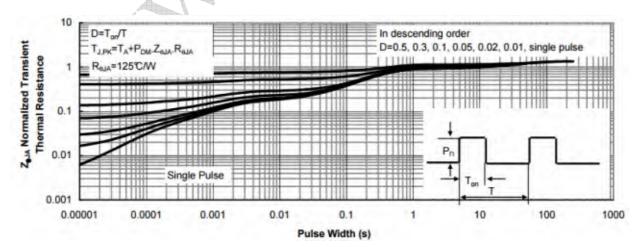
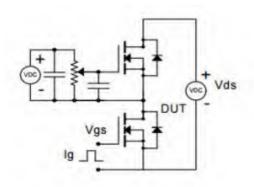


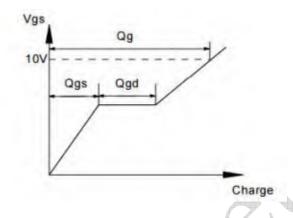
Figure 11: Normalized Maximum Transient Thermal Impedance (Note E)

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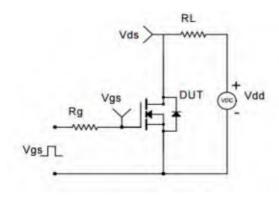


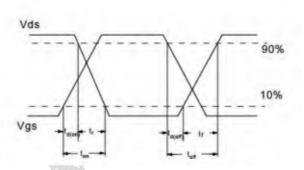
Gate Charge Test Circuit & Waveform



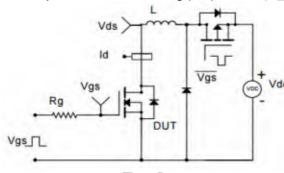


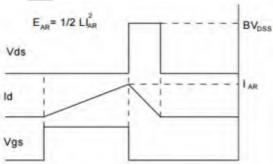
Resistive Switching Test Circuit & Waveforms



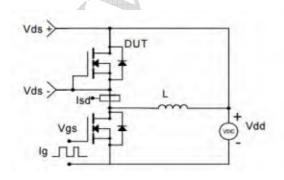


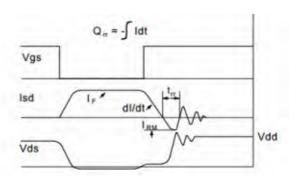
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms



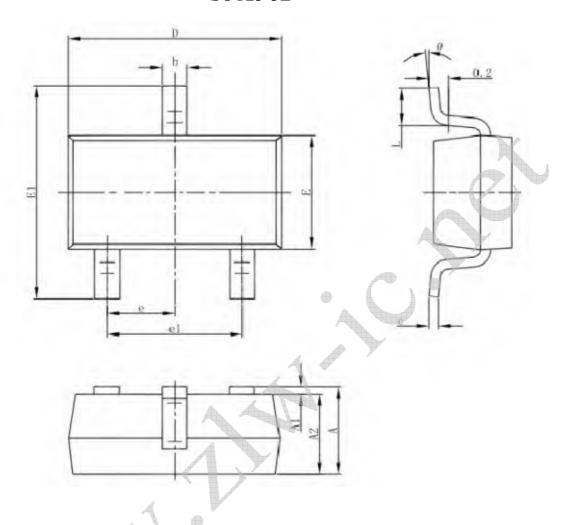


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Package Information

SOT23-3L



Symbol	Dimensions In	Millimeters	Dimensions	In Inches
	Min	Max	Min	Max
Α	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
C	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
е	0.950(BSC)		0.037	(BSC)
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

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